imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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MCR12DG, MCR12MG, MCR12NG

Silicon Controlled Rectifiers Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave silicon gate-controlled devices are needed.

Features

- Blocking Voltage to 800 Volts
- On-State Current Rating of 12 Amperes RMS at 80°C
- High Surge Current Capability 100 Amperes
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT an IH Specified for Ease of Design
- High Immunity to dv/dt 100 V/µsec Minimum at 125°C
- These are Pb–Free Devices

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) ($T_J = -40$ to 125°C, Sine Wave, 50 to 60 Hz, Gate Open)	V _{DRM,} V _{RRM}		V
MCR12DG MCR12MG MCR12NG		400 600 800	
On-State RMS Current (180° Conduction Angles; T _C = 80°C)	I _{T(RMS)}	12	A
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 125^{\circ}C$)	I _{TSM}	100	A
Circuit Fusing Consideration (t = 8.33 ms)	l ² t	41	A ² sec
Forward Peak Gate Power (Pulse Width \leq 1.0 μ s, T _C = 80°C)	P _{GM}	5.0	W
Forward Average Gate Power (t = 8.3 ms, $T_C = 80^{\circ}C$)	P _{G(AV)}	0.5	W
Average On-State Current (180° Conduction Angles; T _C = 80°C)	I _{T(AV)}	7.8	A
Forward Peak Gate Current (Pulse Width \leq 1.0 μ s, T _C = 90°C)	I _{GM}	2.0	A
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

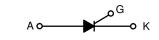
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

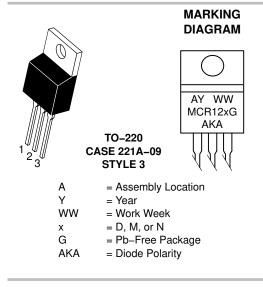
1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



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	PIN ASSIGNMENT
1	Cathode
2	Anode
3	Gate
4	Anode

ORDERING INFORMATION

Device	Package	Shipping
MCR12DG	TO–220AB (Pb–Free)	50 Units / Rail
MCR12MG	TO–220AB (Pb–Free)	50 Units / Rail
MCR12NG	TO–220AB (Pb–Free)	50 Units / Rail

MCR12DG, MCR12MG, MCR12NG

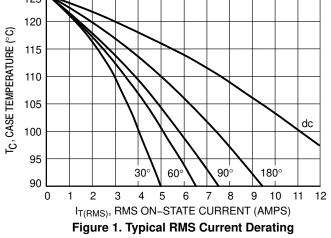
THERMAL CHARACTERISTICS

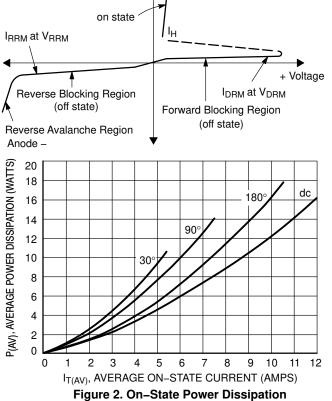
Characteristic	Symbol		Value		Unit
Thermal Resistance, Junction-to-Case Junction-to-Ambient	$R_{ extsf{ heta}JC} \ R_{ heta}JA$		2.2 62.5		°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL		260		°C
ELECTRICAL CHARACTERISTICS (T _J = 25°C unless otherwise noted)					
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Peak Repetitive Forward or Reverse Blocking Current $(V_D = Rated V_{DRM} and V_{RRM}; Gate Open)$ $T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$	I _{DRM} , I _{RRM}			0.01 2.0	mA
ON CHARACTERISTICS					
Peak Forward On–State Voltage (Note 2) (I _{TM} = 24 A)	V _{TM}	-	-	2.2	V
Gate Trigger Current (Continuous dc) (V _D = 12 V; R _L = 100 Ω)	I _{GT}	2.0	8.0	20	mA
Holding Current (V _D = 12 V, Gate Open, Initiating Current = 200 mA)	Ι _Η	4.0	20	40	mA
Latch Current ($V_D = 12 \text{ V}, I_G = 20 \text{ mA}$)	١L	6.0	25	60	mA
Gate Trigger Voltage (Continuous dc) (V _D = 12 V; R _L =100 Ω)	V _{GT}	0.5	0.65	1.0	V
DYNAMIC CHARACTERISTICS					
Critical Rate of Rise of Off–State Voltage $(V_D = Rated V_{DRM}, Exponential Waveform, Gate Open, T_J = 125^{\circ}C)$	dv/dt	100	250	-	V/µs
Repetitive Critical Rate of Rise of On-State Current	di/dt	-	-	50	A/μs

IPK = 50 A, Pw = 40 µsec, diG/dt = 1 A/µsec, Igt = 50 mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Voltage Current Characteristic of SCR + Current Symbol Parameter Peak Repetitive Off State Forward Voltage V_{DRM} on state Peak Forward Blocking Current IDRM Ι_Η I_{RRM} at V_{RRM} V_{RRM} Peak Repetitive Off State Reverse Voltage Peak Reverse Blocking Current I_{RRM} Peak On State Voltage V_{TM} Holding Current I_{H} **Reverse Blocking Region** (off state) Reverse Avalanche Region Anode -20 125 18 120 16

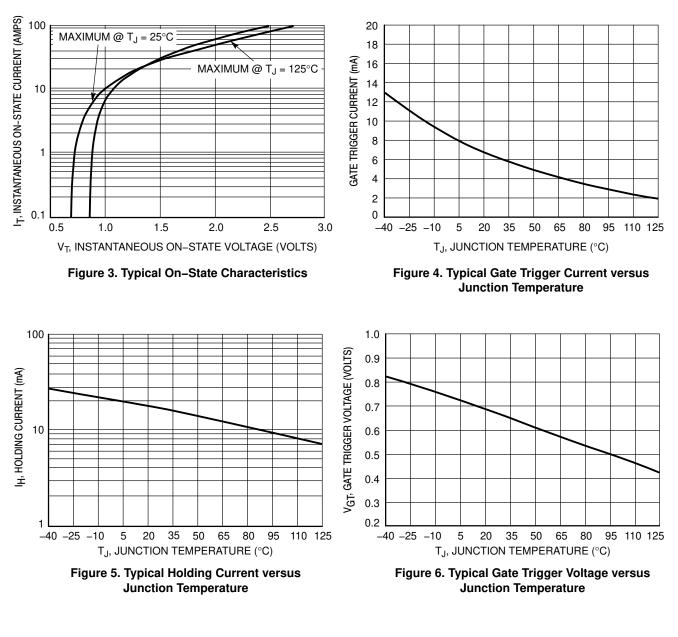


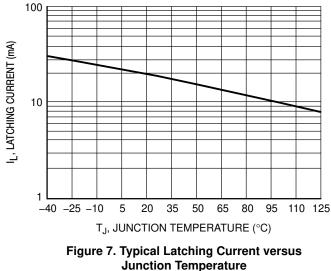


Anode +

тм

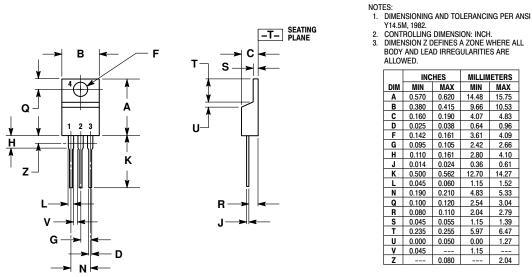
MCR12DG, MCR12MG, MCR12NG





PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH**



	NED.			
	INCHES		S MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Η	0.110	0.161	2.80	4.10
ſ	0.014	0.024	0.36	0.61
Κ	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
s	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Ζ		0.080		2.04

STYLE 3: PIN 1. CATHODE 2. ANODE GATE 3. 4. ANODE

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